

SPICE Model for MOSFETs in sedra_lib.lib (1/2)

Table B.2 Parameters of the SPICE Level-1 MOSFET Model (Partial Listing)

SPICE Parameter	Book Symbol	Description	Units
Basic Model Parameters			
LEVEL		MOSFET model selector	
TOX	t_{ox}	Gate-oxide thickness	m
COX	C_{ox}	Gate-oxide capacitance, per unit area	F/m ²
UO	μ	Carrier mobility	cm ² /V·s
KP	k'	Process transconductance parameter	A/V ²
LAMBDA	λ	Channel-length modulation coefficient	V ⁻¹
Threshold Voltage Parameters			
VTO	V_{t0}	Zero-bias threshold voltage	V
GAMMA	γ	Body-effect parameter	V ^{1/2}
NSUB	N_A, N_D	Substrate doping	cm ⁻³
PHI	$2\phi_f$	Surface inversion potential	V
MOSFET Diode Parameters			
JS		Body-junction saturation-current density	A/m ²
CJ		Zero-bias body-junction capacitance, per unit area over the drain/source region	F/m ²
MJ		Grading coefficient, for area component	
CJSW		Zero-bias body-junction capacitance, per unit length along F/m the sidewall (periphery) of the drain/source region	
MJSW		Grading coefficient, for sidewall component	
PB	V_0	Body-junction built-in potential	V
MOSFET Dimension Parameters			
LD	L_{ov}	Lateral diffusion into the channel from the source/drain diffusion regions	m
WD		Sideways diffusion into the channel from the body along the width	m
MOS Gate-Capacitance Parameters			
CGBO		Gate-body overlap capacitance, per unit channel length	F/m
CGDO	C_{ov}/W	Gate-drain overlap capacitance, per unit channel width	F/m
CGSO	C_{ov}/W	Gate-source overlap capacitance, per unit channel width	F/m

SPICE Model for MOSFETs in sedra_lib.lib (2/2)

Technology	L_{\min}	W_{\min}	$(V_{DD} + V_{SS})_{\max}$
5- μm CMOS	5 μm	12.5 μm	10 V
0.5- μm CMOS	0.5 μm	1.25 μm	3.3 V
0.18- μm CMOS	0.18 μm	0.22 μm	1.8 V

L_{\min} : minimum channel length

W_{\min} : minimum channel width

$(V_{DD} + |V_{SS}|)_{\max}$: maximum supply voltage

Table B.3 Values of the Level-1 MOSFET Model Parameters for Two CMOS Technologies¹

	5- μm CMOS Process		0.5- μm CMOS Process		0.18- μm CMOS Process	
	NMOS	PMOS	NMOS	PMOS	NMOS	PMOS
LEVEL	1	1	1	1	1	1
TOX	8.50e-08	8.50e-08	9.50e-09	9.50e-09	4.08e-09	4.08e-09
UO	750	250	460 680	115 200	291	102
LAMBDA	0.01	0.03	0.1	0.2	0.08	0.11
GAMMA	1.4	0.65	0.5	0.45	0.3	0.3
VTO	1	-1	0.7	-0.8	0.5	-0.45
PHI	0.7	0.65	0.8	0.75	0.84	0.8
LD	7.00e-07	6.00e-07	8.00e-08	9.00e-08	10e-9	10e-9
JS	1.00e-06	1.00e-06	1.00e-08	5.00e-09	8.38e-6	4.00e-07
CJ	4.00e-04	1.80e-04	5.70e-04	9.30e-04	1.60e-03	1.00e-03
MJ	0.5	0.5	0.5	0.5	0.5	0.45
CJSW	8.00e-10	6.00e-10	1.20e-10	1.70e-10	2.04e-10	2.04e-10
MJSW	0.5	0.5	0.4	0.35	0.2	0.29
PB	0.7	0.7	0.9	0.9	0.9	0.9
CGBO	2.00e-10	2.00e-10	3.80e-10	3.80e-10	3.80e-10	3.50e-10
CGDO	4.00e-10	4.00e-10	4.00e-10	3.50e-10	3.67e-10	3.43e-10
CGSO	4.00e-10	4.00e-10	4.00e-10	3.50e-10	3.67e-10	3.43e-10

Vacuum permittivity:

$$\epsilon_0 = 8.854 \times 10^{-12} (\text{F} \cdot \text{m}^{-1})$$

Oxide permittivity:

$$\epsilon_{\text{ox}} = 3.9\epsilon_0$$

¹In PSpice, we have created MOSFET parts corresponding to the above models. Readers can find these parts in the SEDRA.olb library, which is available online at www.oup.com/us/sedrasmith. The NMOS and PMOS parts for the 0.5- μm CMOS technology are labeled NMOS0P5_BODY and PMOS0P5_BODY, respectively. The NMOS and PMOS parts for the 5- μm CMOS technology are labeled NMOS5P0_BODY and PMOS5P0_BODY, respectively. Furthermore, parts NMOS5P0 and PMOS5P0 are created to correspond to, respectively, part NMOS0P5_BODY with its body connected to net 0 and part PMOS0P5_BODY with its body connected to net V_{DD} .